

Surface Mount Phase Detector

SYPD-52W+

50Ω High Output 300 to 650 MHz



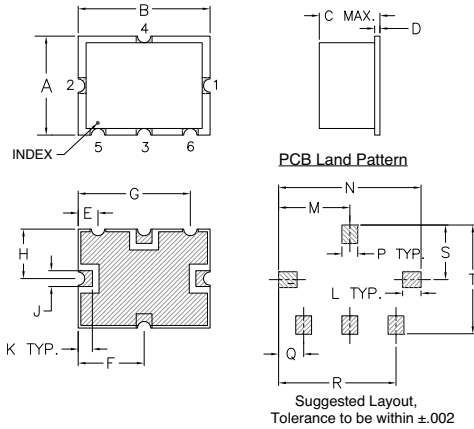
Maximum Ratings

Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
Input Power	50 mW
Peak IF current	20 mA

Pin Connections

RF REF (RF2)	2
RF IN (RF1)	1
DC OUT (I)	3
GROUND	4,5,6

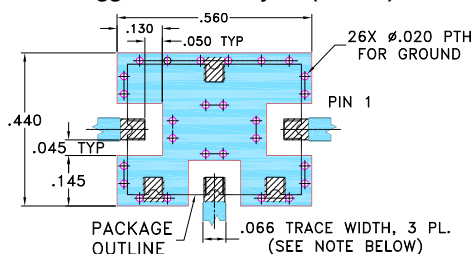
Outline Drawing



Outline Dimensions (inch/mm)

A	B	C	D	E	F	G	H	J	K	L	M	N	P	Q	R	S	T	wt.
.38	.50	.23	.020	.075	.250	.425	.187	.050	.050	.070	.270	.540	.060	.095	.445	.208	.415	grams
9.60	12.70	5.84	0.51	1.91	6.35	10.80	4.75	1.27	1.27	1.78	6.86	13.72	1.52	2.41	11.30	5.28	10.54	0.8

Demo Board MCL P/N: TB-12 Suggested PCB Layout (PL-079)



- NOTE:
- TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 - GROUND PAD SHALL BE FREE OF SOLDER MASK IF REQUIRED FOR SOLDERING.
 - BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
 - DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER), SEE NOTE 2.
 - DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Features

- frequency range, 300 to 650 MHz
- high DC output, 900 mV typ.

Applications

- monitoring circuits
- leveling circuits
- PLL

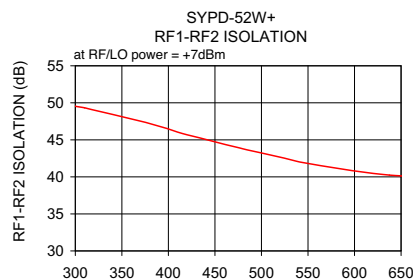
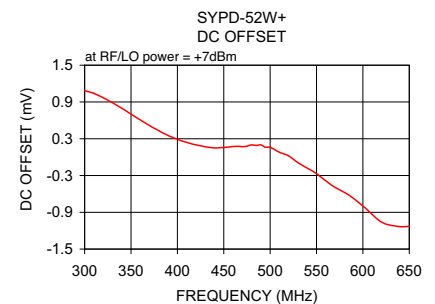
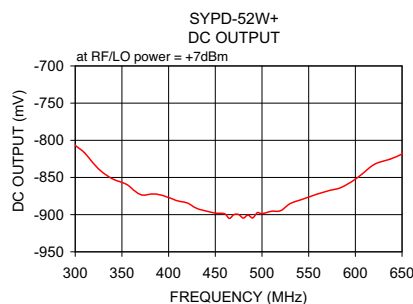
+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Phase Detector Electrical Specifications

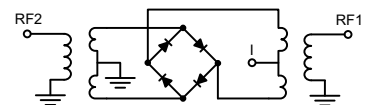
FREQUENCY (MHz)	POWER IN RF1 RF2 (dBm)	SCALE FACTOR mV/deg.	IMPEDANCE (ohms) Output Load I	ISOLATION (dB) RF1/RF2 Min.	OUTPUT POLARITY RF1/RF2 In - Phase	DC OUTPUT (mV)				FIGURE OF MERIT Typ.	
						Max. Typ.	Offset Typ.	Max.	Typ.		
300-400	DC-50	+7	8	500	34	neg.	850	700	0.9	4.0	129
400-500	DC-50	+7	8	500	30	neg.	900	750	0.7	2.5	129
500-650	DC-50	+7	8	500	28	neg.	850	700	1.0	5.0	129

Typical Performance Data

Frequency (MHz)	DC Output mV		DC Offset mV		RF1-RF2 Isolation (dB) X
	\bar{X}	σ	\bar{X}	σ	
300.0	-806.7	10.04	1.09	0.52	49.54
325.0	-838.5	9.84	0.93	0.46	48.86
340.0	-852.0	9.52	0.80	0.42	48.41
355.0	-859.3	9.22	0.65	0.37	47.98
385.0	-872.0	8.24	0.39	0.32	47.04
400.0	-877.0	7.60	0.29	0.35	46.44
430.0	-891.6	7.18	0.17	0.45	45.36
450.0	-897.9	6.93	0.16	0.54	44.73
485.0	-900.5	6.57	0.19	0.70	43.64
500.0	-898.7	6.49	0.16	0.77	43.23
550.0	-876.4	6.16	-0.27	1.04	41.80
585.0	-863.3	6.63	-0.62	1.20	41.11
602.5	-850.1	6.95	-0.83	1.26	40.74
620.0	-832.6	7.64	-1.06	1.37	40.47
650.0	-818.3	8.97	-1.13	1.60	40.13



electrical schematic



Notes

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



Phase Detector (High DC Output)

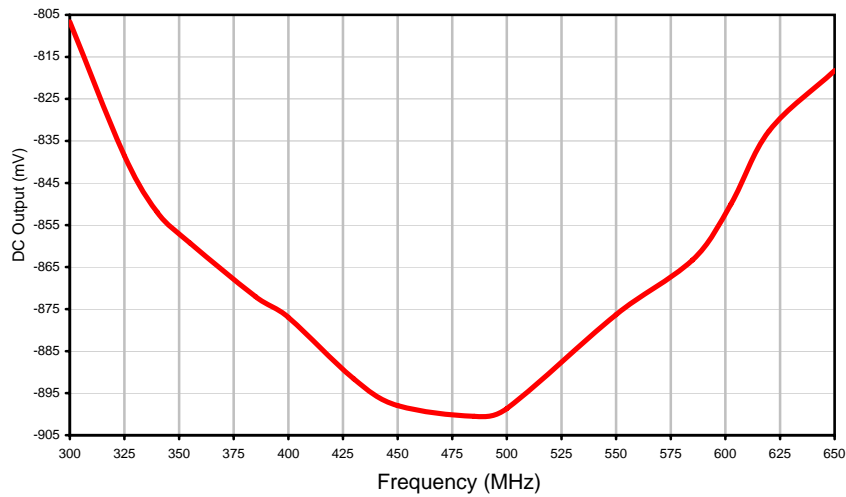
SYPD-52W+

Typical Performance Data

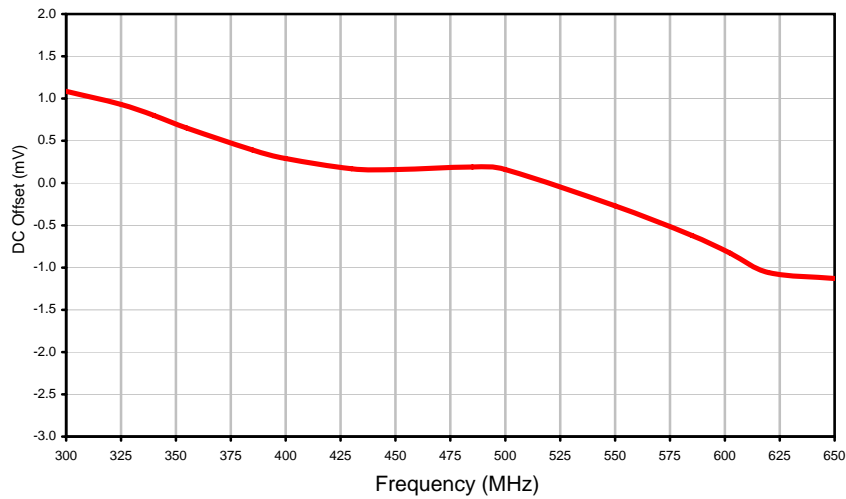
FREQUENCY (MHz)	DC OUTPUT (mV)	DC OFFSET (mV)	RF1-RF2 ISOLATION (dB)
300.00	-806.66	1.09	49.54
325.00	-838.51	0.93	48.86
340.00	-851.95	0.80	48.41
355.00	-859.28	0.65	47.98
385.00	-872.04	0.39	47.04
400.00	-877.00	0.29	46.44
430.00	-891.59	0.17	45.36
450.00	-897.94	0.16	44.73
485.00	-900.49	0.19	43.64
500.00	-898.70	0.16	43.23
550.00	-876.35	-0.27	41.80
585.00	-863.33	-0.62	41.11
602.50	-850.06	-0.83	40.74
620.00	-832.64	-1.06	40.47
650.00	-818.26	-1.13	40.13

Typical Performance Curves

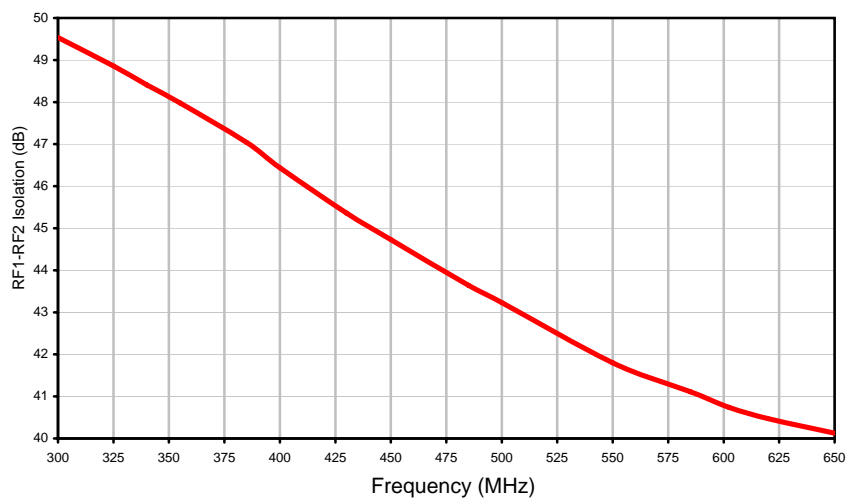
DC Output



DC Offset

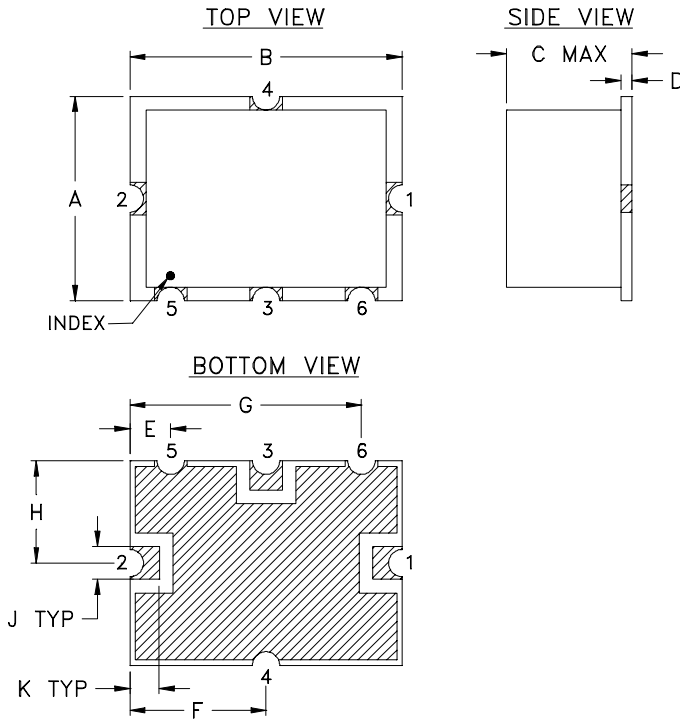


RF1-RF2 Isolation

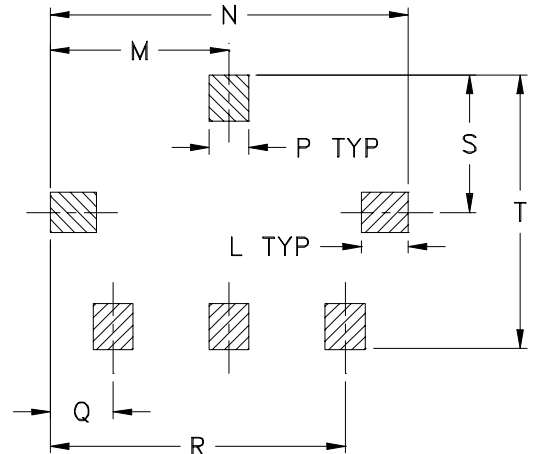


Outline Dimensions

TTT166
TTT167



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N
TTT166	.38 (9.65)	.50 (12.70)	.15 (3.81)	.020 (0.51)	.075 (1.91)	.250 (6.35)	.425 (10.80)	.187 (4.75)	.050 (1.27)	.050 (1.27)	.070 (1.78)	.270 (6.86)	.540 (13.72)
TTT167			.23 (5.84)										

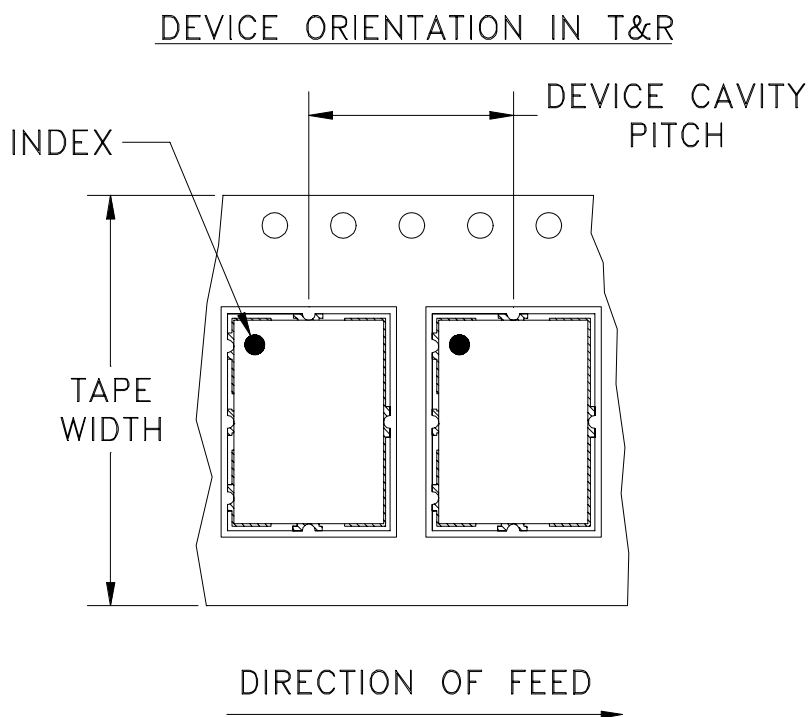
CASE #	P	Q	R	S	T	WT. GRAM
TTT166	.060 (1.52)	.095 (2.41)	.445 (11.30)	.208 (5.28)	.415 (10.54)	.8
TTT167						.8

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Note:

- Case material: Plastic.
- Base material: Printed wiring laminate.
- Termination finish:
 - For RoHS Case Styles: 3-5 μ inch (.08-.13 microns) Gold over 120-240 μ inch (3.05-6.10 microns) Nickel plate. All models, (+) suffix.
 - For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

Tape & Reel Packaging TR-F12



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
24	12	7	Small quantity standards (see note)	10
				20
				50
				100
				200
		13	Standard	500

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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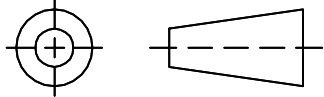
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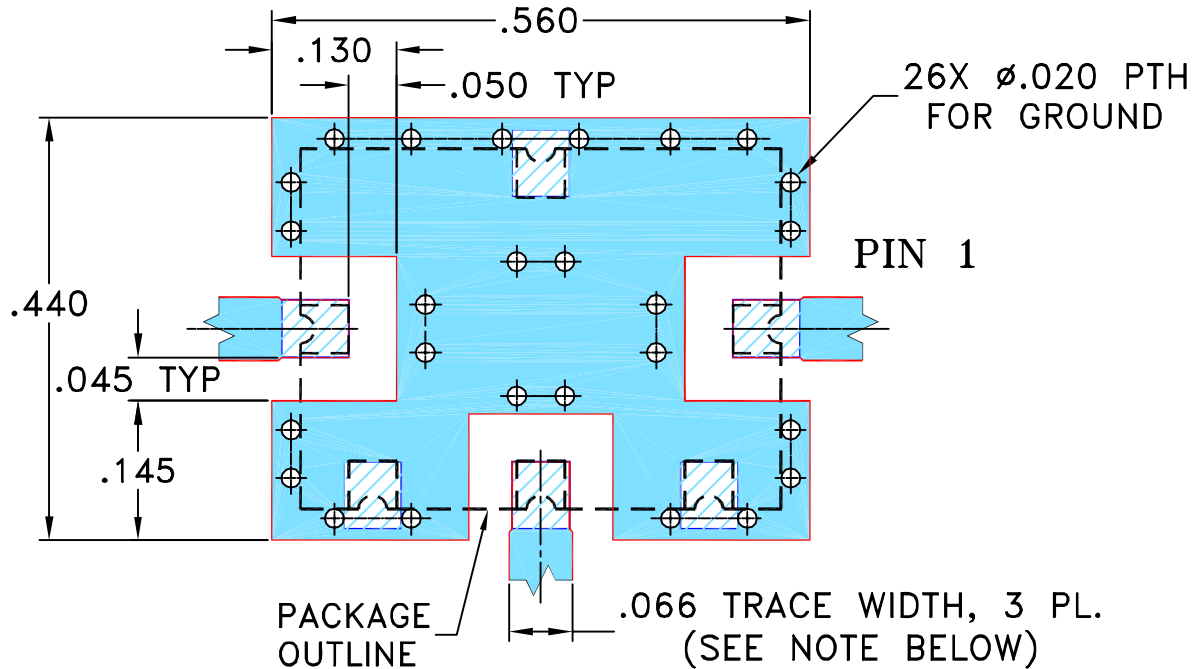
THIRD ANGLE PROJECTION



REVISIONS


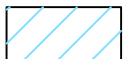
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
A	M86762	ADDED CONNECTIONS "lp & lq"	05/23/03	MMG	WL
B	M94598	ADDED CONNECTION "hk"	10/08/04	MMG	HY
C	M102713	UPDATED NOTES & DESCRIPTION	01/14/06	GF	IL
D	M132989	UPDATED NOTE 2	08/24/11	GF	DJ

SUGGESTED MOUNTING CONFIGURATION FOR
TTT166/167 CASE STYLE, "hk"/"lp"/"lq"
"x"/"ck"/"ec" PIN CONNECTIONS



NOTE:

1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. THE USE OF SOLDER MASK OVER THE GROUND AREA UNDER THE UNIT AS SHOWN IS RECOMMENDED TO PREVENT POTENTIAL SHORTING. IF USER CHOOSES TO EXPOSE METAL UNDER THE ENTIRE UNIT GROUND PAD FOR IMPROVED GROUNDING, IT IS RECOMMENDED A SOLDER MASK DAM BE APPLIED AROUND EACH GROUND PAD TO ENSURE FILLET AND CONNECTION AT GROUND PADS.
3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.


 DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER), SEE NOTE 2.
 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES	GF	03/18/03
TOLERANCES ON:	IL	04/15/03
2 PL DECIMALS ±	DJ	04/15/03
3 PL DECIMALS ± .005		
ANGLES ±		
FRACTIONS ±		

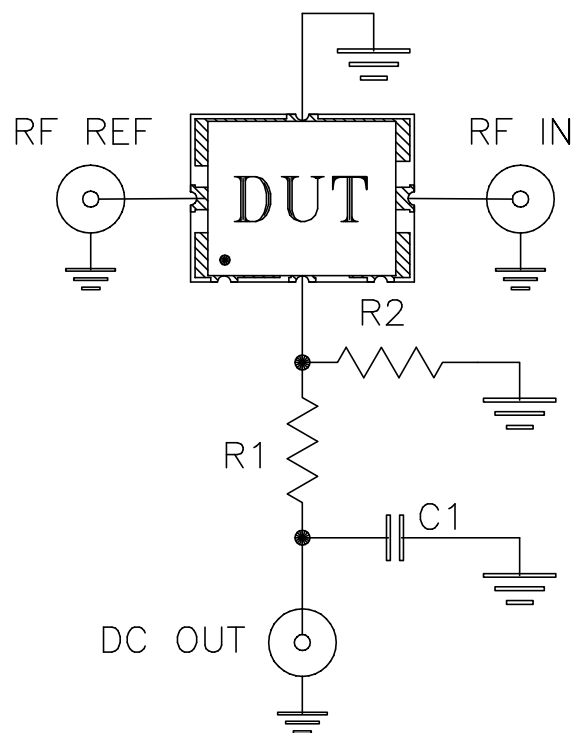
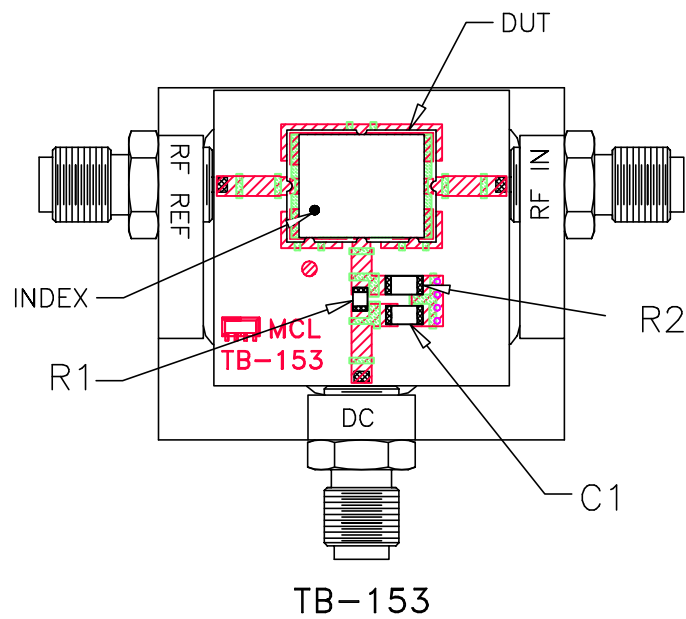
 **Mini-Circuits®** 13 Neptune Avenue
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PL, hk/lp/lq/x/ck/ec, TTT166/167,
SYM/HJK/SYAS/SYPD, TB-12

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-079	D
FILE:	98PL079	SCALE: 5:1	SHEET: 1 OF 1

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Evaluation Board and Circuit




COMPONENT	VALUE	SIZE
C1	Capacitor 0.10 uF	1206
R1	Resistor 5620 Ohm	0805
R2	Resistor 499 Ohm	1206

Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: RO4350 or equivalent,
Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215